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Image

1731



Patent Docket # 5123-27RCE

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of
Bassel H. DAOUD et al.
Serial No.: 09/497,045
Filed: February 02, 2000
For: Mold Incorporating A Heat Source And
Apparatus And Method For Using Such Molds

Examiner: Halpern, Mark
Group Art: 1731

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September 9, 2003
(Date of Deposit)

Lance J. Lieberman
Name of Applicant, assignee or Registered Representative

[Signature]
Signature

September 9, 2003
Date of Signature

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

SUPPLEMENTAL REVISED AMENDMENT

SIR:

In response to the September 03, 2003 Notice of Non-Compliant Amendment, applicants resubmit herewith a complete "Amendments to the Claims" section of its prior Amendment, which herewith-submitted section has been corrected to remedy the deficiencies noted in the September 03, 2003 Notice of Non-Compliant Amendment.

Amendments to the Claims are reflected in the listing of claims which begins on page 02 of this paper.

Remarks begin on page 08 of this paper.